



Product Summary (@ T_A = +25°C)

V _{RRM} (V)	I ₀ (A)	V _F Max (V)	I _R Max (μA)
200	1	0.95	5

Description

The US1DWF is a rectifier packaged in the SOD123F package and is suited as a boost diode in power factor correction circuitry. For use in secondary rectification and freewheeling for ultra-fast switching speed AC-AC and DC-DC converters in high-temperature conditions for consumer applications.

Applications

- Flat Panel Display
- Switching Power Supplies/Chargers
- LED Lighting
- Freewheeling Diode

1.0A SURFACE MOUNT ULTRA-FAST RECTIFIER

Features and Benefits

- Low Profile, Small Form Factor Package
- Low Leakage Current
- **Glass Passivate Die Construction**
- Enhanced Ultrafast Recovery Times for High Efficiency
- Low Forward Voltage, Low Power Loss
- Lead-Free Finish & RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SOD123E
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Polarity: Cathode Band
- Weight: 0.016 grams (Approximate)

SOD123F





Top View



Schematic View

Ordering Information (Note 4)

Part Number	Qualification	Case	Packaging
US1DWF-7	AEC-Q101	SOD123F	3,000/Tape & Reel

Notes:

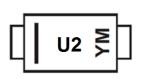
1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied. 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + CI) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information

SOD123F



U2 = Product Type Marking Code

- YM = Date Code Marking Y = Year (ex: E = 2017)
- M = Month (ex: 9 = September)

Date	Code	Key

Year	1	2015	2016	20	017	2018	201	9	2020	2021		2022
Code		С	D		E	F	G		Н			J
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	0	2	1	5	6	7	0	0	\cap	N	



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	200	V
Average Rectified Output Current	lo	1	А
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	30	А

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Case	R _{θJC}	34	°C/W
Typical Thermal Resistance Junction to Ambient (Note 5)	R _{0JA}	96	°C/W
Typical Thermal Resistance Junction to Ambient (Note 6)	R _{0JA}	87	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	٥C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

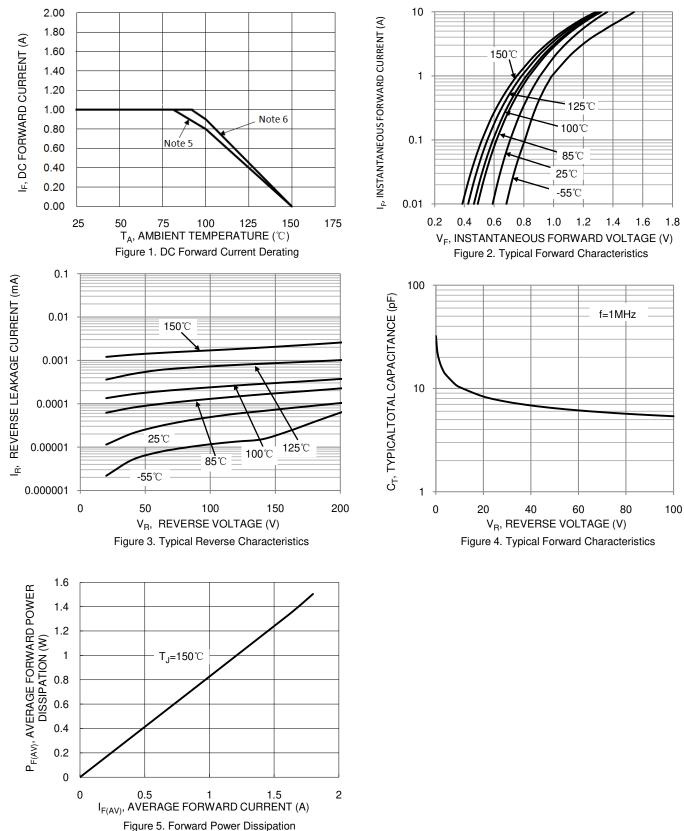
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	V _{(BR)R}	200	—	—	V	$I_R = 10 \mu A$
Forward Voltage	V _F	_	0.9 0.8	0.95	V	$I_F = 1A, T_J = +25^{\circ}C$ $I_F = 1A, T_J = +125^{\circ}C$
Reverse Leakage Current (Note 7)	I _R	_	0.1 1.0	5 100	μA	$V_R = 200V, T_J = +25^{\circ}C$ $V_R = 200V, T_J = +125^{\circ}C$
Reverse Recovery Time	t _{RR}	_	30	35	ns	$I_F = 0.5A, I_R = 1.0A, I_{RR} = 0.25A$
Typical Total Capacitance	CT	_	14		pF	$V_R = 4V$, f=1MHz

Notes:

Device mounted on FR-4 substrate, 25.4*25.4mm, 2oz, single-sided, PC boards with 2.1*2.1mm copper pad.
Device mounted on FR-4 substrate, 0.4"*0.5", 2oz, single-sided, PC boards with 0.2"*0.25" copper pad.
Short duration pulse test used to minimize self-heating effect.



US1DWF

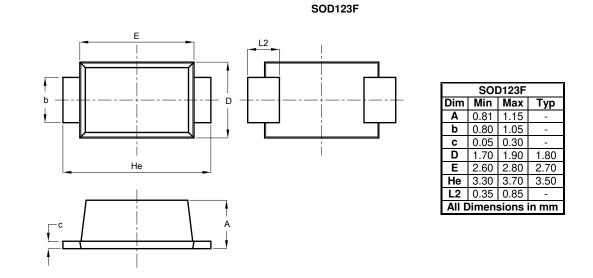


NEW PRODUCT



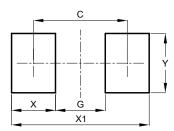
Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.



Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
С	2.86
G	1.52
Х	1.34
X1	4.20
Y	1.80

SOD123F



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